L Number	Hits		DB	Time stamp
16	17	bismaleimide and (snap adj cure)	USPAT; DERWENT	2003/11/03 11:43
17	Θ	(silica near3 die) and (bismaleimide and	USPAT;	2003/11/03 11:33
18	0	(snap adj cure)) (silica near die) and (bismaleimide and (snap adj cure))	DERWENT USPAT;	2003/11/03 11:33
19	0	(silica near die) and bismaleimide	DERWENT USPAT; DERWENT	2003/11/03 11:35
20	14	(silica near die)	USPAT; DERWENT	2003/11/03 11:35
21	3811	(silica or silcone or silicon) near3 die	USPAT; DERWENT	2003/11/03 11:36
22	19590	(silver or Ag) near3 (frame or substrate or film)	USPAT; DERWENT	2003/11/03 11:37
23	692	(silver or Ag) near3 frame	USPAT; DERWENT	2003/11/03 11:37
24	111237	(silica or silcone or silicon) near3 (die or substrate)	USPAT; DERWENT	2003/11/03 11:38
25	129532	((silica or silcone or silicon) near3 die) ((silver or Ag) near3 (frame or substrate or film)) ((silver or Ag) near3 frame) ((silica or silcone or silicon) near3 (die	USPAT; DERWENT	2003/11/03 11:38
26	240	or substrate)) (((silica or silcone or silicon) near3 die) ((silver or Ag) near3 (frame or substrate or film)) ((silver or Ag) near3 frame) ((silica or silcone or silicon) near3 (die or substrate))) and	USPAT; DERWENT	2003/11/03 11:39
27	11	bismaleimide	USPAT; DERWENT	2003/11/03 11:41
28	16	near3 (die or substrate))) and bismaleimide) and (snap adj cure) ("4028135" "4159221" "4507672" "4769399" "4816426" "5011786" "5072283" "5143785" "5150193"	USPAT	2003/11/03 11:40
29	3	"5173766" "5175060" "5274913" "5296738" "5436203" "5469333" "5473814") PN. (("4028135" "4159221" "4507672" "4769399" "4816426" "5011786" "5072283" "5143785" "5150193"	USPAT; DERWENT	2003/11/03 11:42
30	0	"5173766" "5175060" "5274913" "5296738" "5436203" "5469333" "5473814").PN.) and bismaleimide ((("4028135" "4159221" "4507672" "4769399" "4816426" "5011786" "5072283" "5143785" "5150193" "5173766" "5175060" "5274913"	USPAT; DERWENT	2003/11/03 11:42
31	6	"5296738" "5436203" "5469333" "5473814") PN.) and bismaleimide) and (snap adj cure) maleimide and (snap adj cure)	USPAT; DERWENT	2003/11/03 11:44
32	10 2	5475048.URPN. ("4740830").PN.	USPAT USPAT;	2003/11/03 11:46 2003/10/29 15:14
_	8	("3497774" "3985928" "3990896" "4323662" "441767" "4436785"	DERWENT USPAT	2003/06/19 06:54
-		"4459166" "4519941").PN. 4740830.URPN. ((bismaleimide or polybismaleimide or polyimide) near3 (aliphatic or aromatic))	USPAT USPAT; DERWENT	2003/06/19 06:58 2003/06/20 11:49

2						
and photoinitiator) and (conductive adj filler) ("340312" "437046" "4540650" "2003/06/19 07:04 2003/06/19 07:04 2003/06/19 07:04 2003/06/19 07:04 2003/06/19 07:09 2003/06/29 12:24 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 12:34 2003/06/29 13:05 2003/06/29 13:05 2003/06/29 13:05 2003/06/29 13:05 2003/06/29 13:05 2003/06/29 13:05 2003/06/29 13:05 2003/06/29 13:05 2003/	-	Ĭ	2			2003/06/19 07:13
Filler "4363172" "4370467" "4540650" USPAT 2003/06/19 07:04		İ			DERWENT	
#381461" "4806608" "488642").PN. 2003/06/19 07:09						
86	-		6		USPAT	2003/06/19 07:04
182 S22/142 CCLS. USPAT: DERNEMT 2003/06/19 07:09	-		86		USPAT;	2003/06/19 07:09
182 (522/164).CCLS. USPAT: 2003/06/19 07:09			9		DERWENT	
166 (522/164).CCLS. DERNEMT SPAT; DERNEMT DE	_		182		IISPAT.	2003/06/19 07:09
31 (522/176).CCLS. DERWENT USPAT: DERWENT USPAT	-		102	(322/142).0013.		2003/00/13 07.03
31	-		166	(522/164).CCLS.		2003/06/19 07:09
0						2002/06/10 07 12
0	-		31	(522/176).CCLS.		2003/06/19 07:12
polyimide) near3 (aliphatic or aromatic) and (((((((((((((((((((((((((((((((((((_		Θ	(((bismaleimide or polybismaleimide or		2003/06/19 07:14
and (conductive adj filler) 26 ((bismaleimide or polybismaleimide or polybismaleim				polyimide) near3 (aliphatic or aromatic))		
26						
DOLYMINDE Near3 (aliphatic or aromatic) and ((522/142).CLS.) ((522/143).CLS.)	 		26		115 DAT.	2003/06/20 12:24
and (((522/142).CCLS.) ((522/164).CCLS.)) (("6634194").PN.) and (liquid near3 (bismaleimide or maleimide)) ((bismaleimide or maleimide)) ((bismaleimide or polybismaleimide or polyminide) near3 (aliphatic or (straight adj chain)) near3 liquid (((bismaleimide or polybismaleimide or po	_	ĺ	20			2003/00/20 12.24
(bismaleimide or maleimide)				and (((522/142).CCLS.) ((522/164).CCLS.))		
8	-		1			2003/06/20 11:50
polyimide) near3 (aliphatic or (straight adj chain))) near3 liquid ((bismaleimide or polybismaleimide or polybismaleimide or polyimide) near3 liquid) ((bismaleimide or polybismaleimide or polyimide) near3 liquid)) and peroxide (((bismaleimide or polybismaleimide or polybismaleimide or polyimide) near3 liquid)) and peroxide ((3643172" "4370467" "4540650" USPAT; 2003/06/20 13:05 perwent and adhesive ("3403172" "4370467" "4540650" USPAT (526/262).CCLS.)	_		R			2003/06/20 13:05
1785	- 		°			2003/00/20 13:03
Delymide near3 liquid DERWENT		ĺ				
113	-		1785			2003/06/20 12:31
Determinde Det	_	į	113			2003/06/20 12:31
Temporary Composition or adheisve or resin)	-		113			2003/00/20 12:32
and adhesive ("3403172" "4370467" "4540650" USPAT "4581461" "4806608" "4886842").PN. 664 (526/262).CCLS. 31 (((bismaleimide or polybismaleimide or polybimide) near3 liquid)) and ((526/262).CCLS.) 10 (4876358.URPN. 3 ("3766138" "3855239" "3951902").PN. 10 (4876358.URPN. 3 ("3766138" "3855239" "3951902").PN. 10 (3766138" "3855239" "3951902").PN. 11 (236 ("3766138" "3855239" "3951902").PN. 12 ("3766138" "3855239" "3951902").PN. 13 ("3766138" "3855239" "3951902").PN. 14 ("3766138" "3855239" "3951902").PN. 15 ("3766138" "3951902").PN. 15 ("376138" "3951902").PN. 15 ("376138" "3	-	İ	53			2003/06/20 13:05
- 66 ("3403172" "4370467" "458650" "4581461" "4806608" "4886842").PN. 664 (526/262).CCLS. 31 (((bismaleimide or polybismaleimide or polymide) near3 liquid)) and ((526/262).CCLS.) 4876358.URPN. 10 4876358.URPN. 11 ((3766138" "3855239" "3951902").PN. 12 (3766138" "3855239" "3951902").PN. 13 ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin)) 13 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide 14 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide 15 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide 16 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide 17 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide 18 (((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide 18 ((((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide 19 ((((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) 10 (((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) 10 (((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide)					DERWENT	
- 664 (526/262).CCLS. USPAT; DERWENT (526/262).CCLS. USPAT; DERWENT (526/262).CCLS. USPAT; DERWENT (526/262).CCLS.) - 10 (4876358.URPN. USPAT 2003/06/20 13:21 (3766138" "3855239" "3951902").PN. USPAT 2003/06/20 13:21 (3766138" "385538" "3951902").PN. USPAT 2003/06/21 06:50 (3766138" "3855239" "3951902").PN. USPAT (3766138" "3951902").PN. USP	_		6		USPAT	2003/06/20 12:34
Composition or adheisve or resin Composition Composi						
31	-		664	(526/262).CCLS.		2003/06/20 13:05
Derwent Derw	_		₹1	(((hismaleimide or nolybismaleimide or		2003/06/21 07:02
10	_		31			2003/00/21 0/.02
- 3 ("3766138" "3855239" "3951902").PN. USPAT				((526/262).CCLS.)		
4876358.URPN. die near2 (paste or composition or adheisve or resin) ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin)) ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide)	-	į				
- 8793 die near2 (paste or composition or adheisve or resin) - 236 ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin)) - 26 ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin)))	: -	:	_			
- 236 ((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin)) - 26 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide - 34 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide - (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide - ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide)	: <u>-</u>				USPAT;	
(die near2 (paste or composition or adheisve or resin)) (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide)	1					2002/06/51 05 15
adheisve or resin)) 26 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or composition or adheisve or composition or of other or curing of the composition or of other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition or other or curing of the composition o	-		236			2003/06/21 06:18
- 26 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide - 34 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide - 78 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide - 43 ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide)					DERMENT	
(die near2 (paste or composition or adheisve or resin)) and maleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or	-		26	(((cure or curing) near temperature) and		2003/06/21 06:18
- 34 (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or				(die near2 (paste or composition or	DERWENT	
(die near2 (paste or composition or adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or curing) near temperature) and (die near2 (paste or composition or	_		3.4		IISPAT.	2003/06/21 06:18
adheisve or resin))) and bismaleimide (((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and polyimide ((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or (die near2 (paste or composition or	-		54			2005,00,21 00.10
(die near2 (paste or composition or adheisve or resin))) and polyimide (((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or (die near2 (paste or composition or curing) near temperature)			7.	adheisve or resin))) and bismaleimide		
adheisve or resin))) and polyimide (((((cure or curing) near temperature) and (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or	-		78	(((cure or curing) near temperature) and		2003/06/21 06:18
- 43 (((((cure or curing) near temperature) and USPAT; 2003/06/21 06:19 (die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or			:		DEKWENI	
(die near2 (paste or composition or adheisve or resin))) and maleimide) ((((cure or curing) near temperature) and (die near2 (paste or composition or	-	;	43		USPAT;	2003/06/21 06:19
((((cure or curing) near temperature) and (die near2 (paste or composition or		:	_	(die near2 (paste or composition or		
(die near2 (paste or composition or	İ	!				
		į				
				adheisve or resin)) and bismaleimide))		

- T	99	(((((cure or curing) near temperature) and	USPAT;	2003/06/21 06:19
		(die near2 (paste or composition or	DERWENT	
		adheisve or resin))) and maleimide)		
		((((cure or curing) near temperature) and		
		(die near2 (paste or composition or		İ
		adheisve or resin))) and bismaleimide))		
		((((cure or curing) near temperature) and		j
		(die near2 (paste or composition or		
		adheisve or resin))) and polyimide)		
_	43	((((cure or curing) near temperature) and	USPAT;	2003/06/21 06:47
	1,5	(die near2 (paste or composition or	DERWENT	2003/00/21 00.4/
i		adheisve or resin))) and maleimide)	DERWENT	
		((((cure or curing) near temperature) and		
		(die near2 (paste or composition or		
		adheisve or resin))) and bismaleimide)		
	7		HCDAT.	3003/06/31 06:55
-	,	((((((cure or curing) near temperature)	USPAT;	2003/06/21 06:55
j		and (die near2 (paste or composition or	DERWENT	!
		adheisve or resin))) and maleimide)		1
ļ į		((((cure or curing) near temperature) and		
!		(die near2 (paste or composition or		
!		adheisve or resin))) and bismaleimide)))		
:		and (snap adj (curing or cure))		
-	6	("3903027" "4288571" "4327369" [USPAT	2003/06/21 06:48
		"4767806" "5158708" "5250228").PN.		
-	17	(((522/142).CCLS.) ((522/164).CCLS.)) and	USPAT;	2003/06/21 06:50
		(conductive adj filler)	DERWENT	
i -	Θ	(((522/142).CCLS.) ((522/164).CCLS.)) and	USPAT;	2003/06/21 06:50
		(((((cure or curing) near temperature) and	DERWENT	
		(die near2 (paste or composition or		i
		adheisve or resin))) and maleimide)		
		((((cure or curing) near temperature) and		i
		(die near2 (paste or composition or		
		adheisve or resin))) and bismaleimide))		
<u>-</u>	2	(((522/142).CCLS.) ((522/164).CCLS.)) and	USPAT;	2003/06/21 06:51
	2	(die near2 (paste or composition or	DERWENT	2003/00/21 00.31
l i		adheisve or resin))	DERMENT	
	332		HCDAT.	2002/06/21 06:51
-	332	(((522/142).CCLS.) ((522/164).CCLS.))	USPAT;	2003/06/21 06:51
		(///522/142) 6616) //522/164) 6616)))	DERWENT	2002/05/24 05 54
-	0	((((522/142).CCLS.) ((522/164).CCLS.)))	USPAT;	2003/06/21 06:51
.		and (snap adj (curing or cure))	DERWENT	
-	0	430\$.ccls and (die near2 (paste or	USPAT;	2003/06/21 06:55
		composition or adheisve or resin))	DERWENT	!
-	109	(snap adj (curing or cure))	USPAT;	2003/06/21 06:55
			DERWENT	1
-	0	430\$.ccls and ((snap adj (curing or	USPAT;	2003/06/21 07:01
ļ		cure)))	DERWENT	
-	1250	((silica or silcone or silicon) near3 (die	USPAT;	2003/06/21 07:01
		or substrate)) and ((silver or Ag) near3	DERWENT	
		(frame or substrate or film))		
-	Θ	(((silica or silcone or silicon) near3	USPAT:	2003/06/21 07:01
	-	(die or substrate)) and ((silver or Ag)	DERWENT	2000,007== 07.02
		near3 (frame or substrate or film))) and	DERMENT	
		(((((cure or curing) near temperature) and		
į		(die near2 (paste or composition or		
: 1		adheisve or resin))) and maleimide)		
		((((cure or curing) near temperature) and		
			!	
		(die near2 (paste or composition or		
	304	adheisve or resin))) and bismaleimide))	HEDAT	2002/05/24 44 54
-	304	(((bismaleimide or polybismaleimide or	USPAT;	2003/06/21 11:14
		polyimide))) and (((silica or silcone or	DERWENT	
		silicon) near3 (die or substrate)) and		į
		((silver or Ag) near3 (frame or substrate		
		or film)))		

-	12	((((bismaleimide or polybismaleimide or	USPAT;	2003/06/21 07:16
		polyimide))) and (((silica or silcone or	DERWENT	
		silicon) near3 (die or substrate)) and	i	
		((silver or Ag) near3 (frame or substrate		
İ		or film)))) and (die near2 (paste or		
		composition or adheisve or resin))		
-	8		USPAT	2003/06/21 07:04
	į	"4587038" "4595606" "4732702"		
		"4880570" "4942190").PN.		
-	206	,	USPAT;	, 2003/06/21 09:01
	_	(adhesive or paste)	DERWENT	
-	5	("300" adj "300") near3 die	USPAT;	2003/11/03 11:33
		((300 add 300) add 31) 310 31	DERWENT	2002 104 104 00 40
-	0	(("300" adj "300") adj mil) near3 die	USPAT;	2003/06/21 09:48
	0	//#200# add #200#\ add mil\ manu2 ail	DERWENT	2002/06/24 00 40
-		(("300" adj "300") adj mil) near3 silcone	USPAT;	2003/06/21 09:48
	0	//"200" add "200") add mil	DERWENT	2002/06/21 00:40
-	U	(("300" adj "300") adj mil) near3 silica	USPAT;	2003/06/21 09:49
1_		(hismoleimide or moleimide) near? die	DERWENT	2003/06/31 11:00
-	8	(bismaleimide or maleimide) near3 die	USPAT;	2003/06/21 11:08
!	16	("4369302" "4401776" "4552690"	DERWENT	2003/06/21 10:22
	10	(4369302	USPAT	2003/06/21 10:22
		"4740343" "4740584" "4785075"		1
		"4839442" "4847233" "4861823"	:	
		4053442		
	:	4555066").PN.		
_	11	4369302.URPN.	USPAT	2003/06/21 10:30
ļ <u>-</u>	5	liquid adj maleimide	USPAT;	2003/06/21 10:30
İ		i riquita auj materimitae	DERWENT	2003/00/21 12.21
: _	78	(liquid adj bismaleimide) or (liquid adj	USPAT;	2003/06/21 12:21
	20	maleimide)	DERWENT	2003/00/21 12:21
_	12	((liquid adj bismaleimide) or (liquid adj	USPAT;	2003/06/21 13:47
		maleimide)) and peroxide	DERWENT	2003/00/21 13:4/
_	1	4564663.URPN.	USPAT	2003/06/21 12:24
_	8	("3890272" "3951902" "4116937"	USPAT	2003/06/21 12:24
		"4237262" "4277582" "4564663"	03171	2003/00/21 12.20
		"4579674" "4675414").PN.		f
-	8	4826995.URPN.	USPAT	2003/06/21 12:29
-	0	((liquid adj dimaleimide)) and peroxide	USPAT;	2003/06/21 12:29
		((DERWENT	2005/00/21 15.50
_	373	((dimaleimide)) and peroxide	USPAT;	2003/06/21 13:50
	3,3	CADIMATERMINES, AND PETONIAL	DERWENT	2003/00/21 13.30
	84	(((dimaleimide)) and peroxide) and	USPAT;	2003/06/21 13:52
		adhesive	DERWENT	2305, 03, 21 15.32
-	62	((((dimaleimide)) and peroxide) and	USPAT:	2003/06/21 13:53
İ		adhesive) and filler	DERWENT	2303, 00, 21 13.33
-	0	(((((dimaleimide)) and peroxide) and	USPAT;	2003/06/21 13:53
		adhesive) and filler) and (conductive adi	DERWENT	2303,00,21 13.33
		filler)		
-	64	(((dimaleimide)) and peroxide) and die	USPAT;	2003/06/21 13:57
	!	the state of the s	DERWENT	
-	12	(((((dimaleimide)) and peroxide) and	USPAT;	2003/06/23 06:58
1		adhesive) and filler) and die	DERWENT	
-	59	bismaleimide near2 (aliphatic)	USPAT;	2003/06/23 08:47
		(aribination)	DERWENT	2505,00,25 00.47
-	547	die adj (paste or adhesive or composition)	USPAT;	2003/06/23 07:00
!		3 (part 1. aanda 1.6 or composition)	DERWENT	
-	16	4229550.URPN.	USPAT	2003/06/23 07:07
-	22	4179551.URPN.	USPAT	2003/06/23 07:24
-	13	(("4853449") or ("4886842") or ("4654663")	USPAT	2003/06/23 08:51
	i 1	or ("4740930") or ("4369302") or		-303, 55, 23 00.31
		("4740343") or ("5447988") or ("5536970")		
1		or ("4876358") or ("4323662") or		
		("5489641") or ("5358992") or		
		("4766179")).PN.		
- :	4	(("4740830") or ("4564663")).PN.	USPAT;	2003/10/23 12:08
	<u> </u>		DERWENT	
Search His		/3/03 11:52:49 AM Page 4		

-	9	US-0559961-\$.DID. OR US-5527592-\$.DID. OR	USPAT	2003/10/23 12:08
		US-5470920-\$.DID. OR US-5442039-\$.DID. OR		
		US-5405686-\$.DID. OR US-5359020-\$.DID. OR		
		US-5364700-\$.DID. OR US-5380768-\$.DID. OR		
		US-5475048-\$.DID. OR US-5483101-\$.DID		
-	2	("6034194").PN.	USPAT;	2003/10/23 13:07
			DERWENT	
-	3	6034194.URPN.	USPAT	2003/10/23 13:06
-	16	("4193829" "4578328" "4581461"	USPAT	2003/10/23 13:07
	•	"4621122" "4740830" "4743642"		
		"4803250" "4806608" "4853449"	!	
		"4904360" "5153248" "5246784"	:	
		"5328636" ["5364700" "5380768"		
		"5475048").PN.		
-	17	ma .inv. and (bismaleimide or maleimide)	USPAT;	2003/10/23 15:25
			DERWENT	
(-)	23	liquid adj bismaleimide	USPAT;	2003/10/23 14:18
		· · · · · · · · · · · · · · · · · ·	DERWENT	
; -	112	snap adj cure	USPAT;	2003/10/23 14:00
			DERWENT	į
· _	4	(liquid adj bismaleimide) and (snap adj	USPAT;	2003/10/23 14:02
:	10	cure)	DERWENT	
-	4	((liquid adj bismaleimide) and (snap adj	USPAT:	2003/10/23 14:18
i I		cure)) and adhesion	DERWENT	
-	13	(bismaleimide and (snap adj cure)) and	USPAT:	2003/10/23 14:18
		adhesion	DERWENT	
-	59	versamine	USPAT:	2003/10/23 15:25
		,	DERWENT	
i _	18	versamine adj "552"	USPAT;	2003/10/23 15:25
			DERWENT	
i -	0	maleimide near3 (versamine adi "552")	USPAT;	2003/10/23 15:26
!	_	(,, ,, ,, ,,	DERWENT	
i _	3	bismaleimide near3 (versamine adj "552")	USPAT:	2003/10/23 15:35
		,	DERWENT	
-	3	6034195.URPN.	USPAT	2003/10/23 15:32
! -	19	("H000424" "4193829" "4578328"	USPAT	2003/10/23 15:32
	10	"4581461" "4621122" "4740830"	- 3	
		"4743642" "4766179" "4803250"		
1		"4806608" "4904360" "5153248"		
:		"5246784" "5302661" "5328636"		
:		"5364700" "5380768" "5475048"		
<u> </u>		"5483101").PN.		
_	1	(post adj pressure adj cooker) near3	USPAT;	2003/10/27 12:53
	_ *	adhesion	DERWENT	2003, 10, 2, 12.33
_	10		USPAT;	2003/10/27 13:45
	10	("4235985")).PN.	DERWENT	2003/10/2/ 13.43
_	2	("6470128").PN.	USPAT:	2003/10/27 13:45
		(07/0120).111.	DERWENT	2003/10/2/ 13.43
! _	י	("5595487").PN.	USPAT:	2003/10/30 15:44
		(3333407).TR.	DERWENT	2003/10/30 13.44
_	, c	("6559260").PN.	USPAT;	2003/10/30 15:58
i -	3	(0333200).FN.	DERWENT	2003/10/30 13:30
	1	("6555596").PN.		2003/10/30 15:58
	1	(000000).FN.	USPAT; DERWENT	2003/10/30 13:38
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